

Title (en)

Method of covering a substrate

Title (de)

Verfahren zur Beschichtung eines Substrats

Title (fr)

Procédé de recouvrement d'un substrat

Publication

EP 2927017 A1 20151007 (EN)

Application

EP 14163628 A 20140404

Priority

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Abstract (en)

A method of covering a substrate comprises the steps of supplying a substrate (1), a curable substance (5) and a substantially air-tight transparent film (6), applying a decorative pattern (3) on at least one of the substrate (1) and the film (6), forming a stack of the substrate (1), the substance (5) and the film (6), wherein the substance (5) is sandwiched between the substrate (1) and the film (6), bringing the film (6), the substance (5) and the substrate (1) in close contact to each other and curing the substance (5) by means of radiation through the transparent film (6) and fixing the substance (5) to the film (6) and the substrate (1).

IPC 8 full level

B44C 5/04 (2006.01)

CPC (source: EP)

B44C 5/0469 (2013.01)

Citation (search report)

- [X] EP 1203657 A1 20020508 - IBIDEN CO LTD [JP]
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- [A] EP 0872338 A1 19981021 - DAINIPPON PRINTING CO LTD [JP]

Cited by

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Designated contracting state (EPC)

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Designated extension state (EPC)

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